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March 2015

FDD6635

35V N-Channel PowerTrench® MOSFET

General Description

This N-Channel MOSFET has been produced using Fairchild Semiconductor's proprietary PowerTrench technology to deliver low Rdson and optimized Bvdss capability to offer superior performance benefit in the applications.

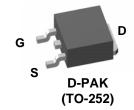
Applications

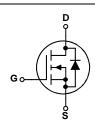
- Inverter
- · Power Supplies

Features

- 59 A, 35 V $R_{DS(ON)} = 10 \ m\Omega \ @ \ V_{GS} = 10 \ V$ $R_{DS(ON)} = 13 \ m\Omega \ @ \ V_{GS} = 4.5 \ V$
- Fast Switching
- · RoHS compliant







Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Source Voltage			35	V
V _{DS(Avalanche)}	Drain-Source Avalanche Voltage (maximum) (Note 4)			40	V
V _{GSS}	Gate-Source Voltage			±20	V
I _D	Continuous Drain Curre	ent @T _c =25°C	(Note 3)	59	А
		@T _A =25°C	(Note 1a)	15	
		Pulsed	(Note 1a)	100	
E _{AS}	Single Pulse Avalanche Energy		(Note 5)	113	mJ
P _D	Power Dissipation	@T _C =25°C	(Note 3)	55	W
		@T _A =25°C	(Note 1a)	3.8	
		@T _A =25°C	(Note 1b)	1.6	
T _J , T _{STG}	Operating and Storage	Junction Tempera	ture Range	-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	2.7	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	°C/W
R _{eJA}	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

Package Marking and Ordering Information

	•					
Device Marking Device		Package	Reel Size	Tape width	Quantity	
FDD6635	FDD6635	D-PAK (TO-252)	13"	16mm	2500 units	

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics(Note 2)				ı	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_{D} = 250 \mu\text{A}$	35			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		32		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 28 \text{ V}, V_{GS} = 0 \text{ V}$			1	μА
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics (Note 2)					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		- 5		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = 10 \text{ V}, \qquad I_D = 15 \text{ A} $ $V_{GS} = 4.5 \text{ V}, \qquad I_D = 13 \text{ A} $ $V_{GS} = 10 \text{ V}, \qquad I_D = 15 \text{ A}, T_J = 125 ^{\circ}\text{C}$		8.2 10.2 12.4	10 13 16	mΩ
g _{FS}	Forward Transconductance	$V_{DS} = 5 \text{ V}, \qquad I_{D} = 15 \text{ A}$		53		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	.,,		1400		pF
C _{oss}	Output Capacitance	$V_{DS} = 20 \text{ V}, \qquad V_{GS} = 0 \text{ V},$ $V_{GS} = 0 \text{ V}, \qquad V_{GS} = 0 \text{ V},$		317		pF
C _{rss}	Reverse Transfer Capacitance	1 = 1.0 MHZ		137		pF
R _G	Gate Resistance	V _{GS} = 15 mV, f = 1.0 MHz		1.4		Ω
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time			11	20	ns
t _r	Turn-On Rise Time	$V_{DD} = 20 \text{ V}, \qquad I_{D} = 1 \text{ A},$		6	12	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		28	45	ns
t _f	Turn-Off Fall Time			14	25	ns
Q _{g (TOT)}	Total Gate Charge, V _{GS} = 10V			26	36	nC
Q_g	Total Gate Charge, V _{GS} = 5V	$V_{DS} = 20 \text{ V}, I_{D} = 15 \text{ A}$		13	18	nC
Q_{gs}	Gate-Source Charge			3.9		nC
Q_{gd}	Gate-Drain Charge			5.3		nC

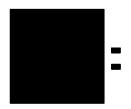
Electrical Characteristics

T_A = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units		
Drain-So	Drain-Source Diode Characteristics							
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 15 \text{ A}$ (Note 2)		0.8	1.2	V		
trr	Diode Reverse Recovery Time	IF = 15 A, diF/dt = 100 A/μs		26		ns		
Qrr	Diode Reverse Recovery Charge			16		nC		

Notes

 R_{8JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{8JC} is guaranteed by design while R_{8CA} is determined by the user's board design.



a) $R_{\theta JA} = 40$ °C/W when mounted on a 1in^2 pad of 2 oz copper



b) $R_{\theta JA} = 96^{\circ} \text{C/W}$ when mounted on a minimum pad.

Scale 1:1 on letter size paper

2. Pulse Test: Pulse Width < 300μ s, Duty Cycle < 2.0%

3. Maximum current is calculated as: $\sqrt{\frac{P_D}{R_{DS(ON)}}}$

where P_D is maximum power dissipation at T_C = 25°C and $R_{DS(on)}$ is at $T_{J(max)}$ and V_{GS} = 10V. Package current limitation is 21A

4. BV(avalanche) Single-Pulse rating is guaranteed if device is operated within the UIS SOA boundary of the device.

5. Starting $T_J = 25^{\circ}C$, L = 1mH, $I_{AS} = 15A$, $V_{DD} = 35V$, $V_{GS} = 10V$

Typical Characteristics

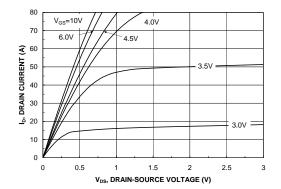


Figure 1. On-Region Characteristics

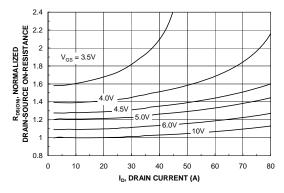


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage

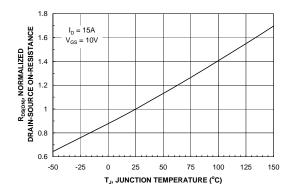


Figure 3. On-Resistance Variation with Temperature

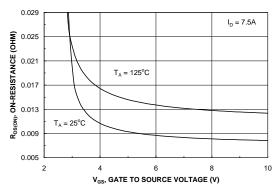


Figure 4. On-Resistance Variation with Gate-to-Source Voltage

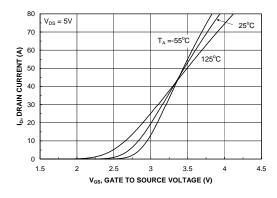


Figure 5. Transfer Characteristics

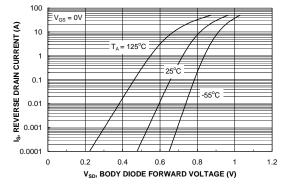


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

Typical Characteristics

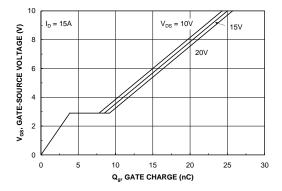


Figure 7. Gate Charge Characteristics

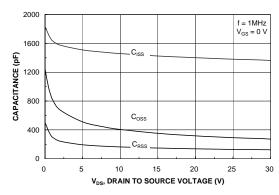


Figure 8. Capacitance Characteristics

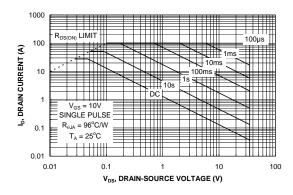


Figure 9. Maximum Safe Operating Area

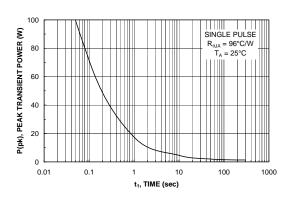


Figure 10. Single Pulse Maximum Power Dissipation

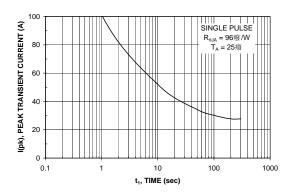


Figure 11. Single Pulse Maximum Peak Current

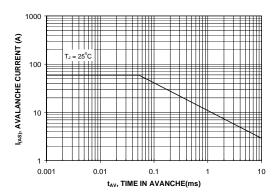


Figure 12. Unclamped Inductive Switching Capability

Typical Characteristics

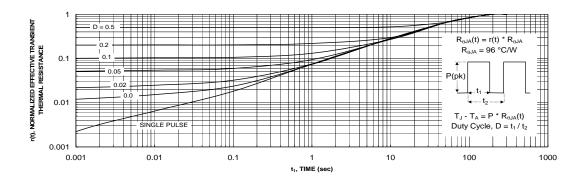
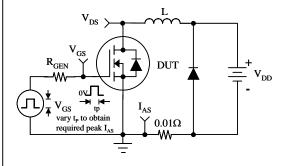


Figure 13. Transient Thermal Response Curve

Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.

Test Circuits and Waveforms



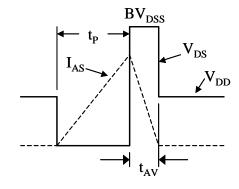
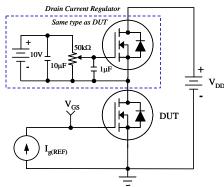
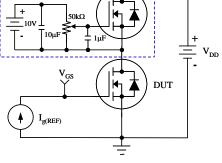


Figure 14. Unclamped Inductive Load Test Circuit

Figure 15. Unclamped Inductive Waveforms





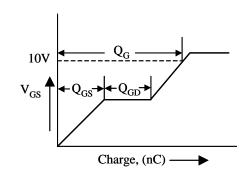
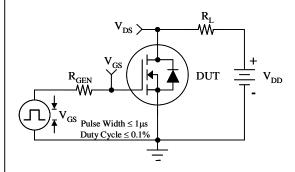


Figure 16. Gate Charge Test Circuit

Figure 17. Gate Charge Waveform



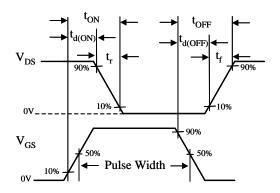
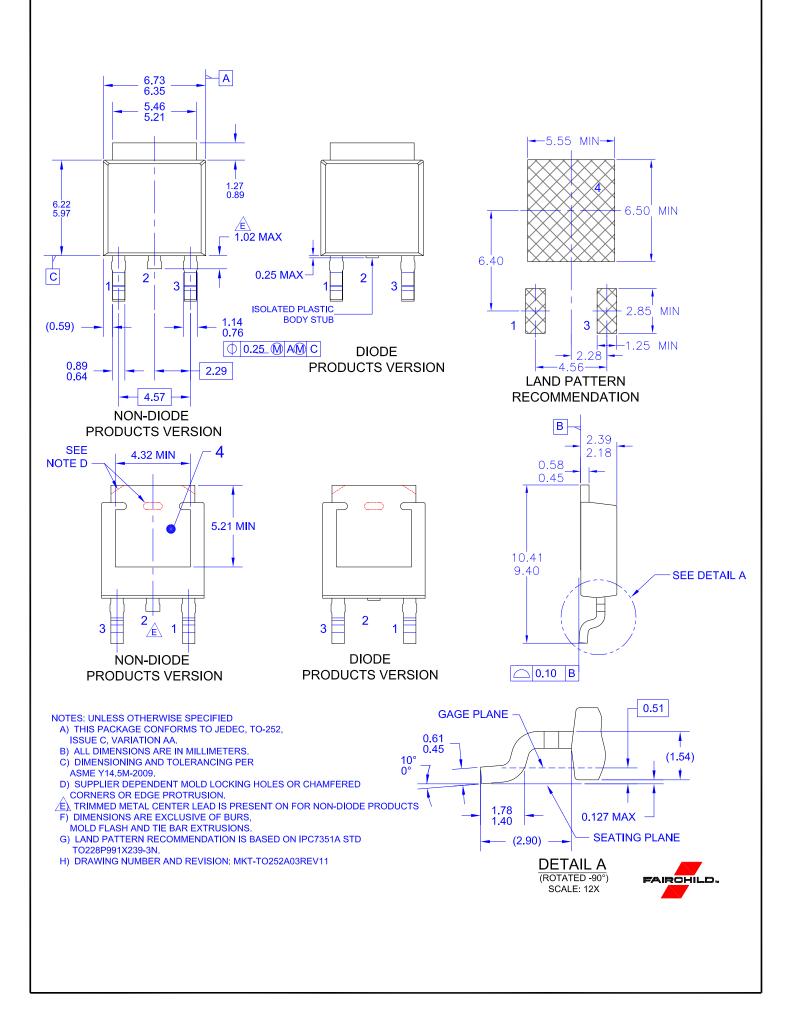


Figure 18. Switching Time Test Circuit

Figure 19. Switching Time Waveforms



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